

TXB0102 2-Bit Bidirectional Voltage-Level Translator With Auto Direction Sensing and ± 15 -kV ESD Protection

1 Features

- Available in the Texas Instruments NanoFree™ Packages
- 1.2 V to 3.6 V on A Port and 1.65 V to 5.5 V On B Port ($V_{CCA} \leq V_{CCB}$)
- V_{CC} Isolation Feature – If Either V_{CC} Input Is at GND, All Outputs Are in the High-Impedance State
- OE Input Circuit Referenced to V_{CCA}
- Low Power Consumption, 4- μ A Max I_{CC}
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - A Port
 - 2500-V Human-Body Model (A114-B)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)
 - B Port
 - 15-kV Human-Body Model (A114-B)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)

2 Applications

- Handsets
- Smartphones
- Tablets
- Desktop PCs

3 Description

The TXB0102 device is a 2-bit noninverting translator that uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes. V_{CCA} must not exceed V_{CCB} .

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

OE must be tied to GND through a pulldown resistor to assure the high-impedance state during power up or power down; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

NanoFree™ technology is a major breakthrough in IC packaging concepts, using the die as the package.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|-----------|-------------------|
| TXB0102DCU | VSSOP (8) | 2.30 mm x 2.00 mm |
| TXB0102YZP | DSBGA (8) | 0.90 mm x 1.80 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Typical Operating Circuit

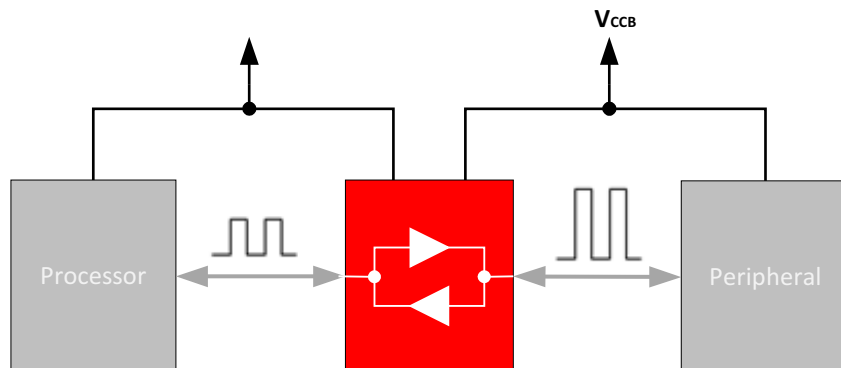


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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

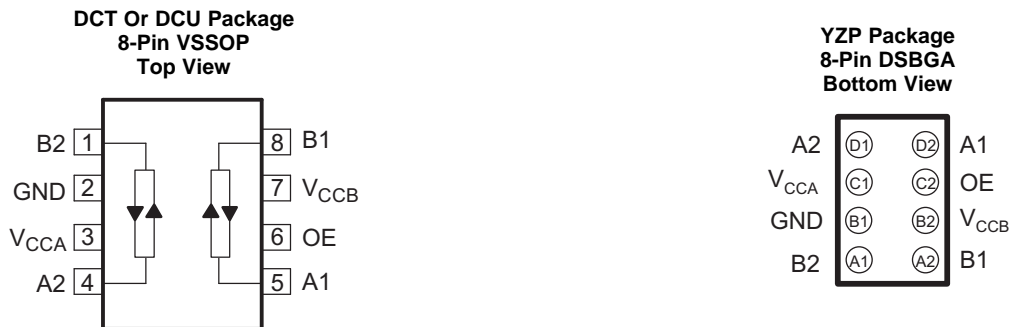
| Changes from Revision C (December 2014) to Revision D | Page |
|--|----------|
| • Changed format of <i>Pin Functions</i> tables. | 3 |
| • Added Junction temperature, T_J in <i>Absolute Maximum Ratings</i> | 4 |

| Changes from Revision B (March 2012) to Revision C | Page |
|--|----------|
| • Added <i>Pin Configuration and Functions</i> section, <i>Handling Rating</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section | 1 |

| Changes from Revision A (January 2011) to Revision B | Page |
|--|----------|
| • Added notes to pin out graphics. | 3 |

| Changes from Original (May 2007) to Revision A | Page |
|--|----------|
| • Added ball labels to the YZP Package. | 3 |

5 Pin Configuration and Functions



- Pullup resistors are not recommended on TXB0102 I/O pins.
- If pullup resistors are needed for open drain communication, please refer to the TXS0102 or contact TI.
- If pullup or pulldown resistors are needed, the resistor value must be over 50 k Ω . See [Effects of External Pullup and Pulldown Resistors on TXS and TXB Devices](#).
- 50 k Ω is a safe recommended value, if the customer can accept higher V_{OL} or lower V_{CCOUT} , smaller pullup or pulldown resistor is allowed, the draft estimation is $V_{OL} = V_{CCOUT} \times 4.5k / (4.5k + R_{pu})$ and $V_{OH} = V_{CCOUT} \times R_{dw} / (4.5k + R_{dw})$.
- For detailed information, See [A Guide to Voltage Translation With TXB-Type Translators](#).

Pin Functions: YZP

| PIN | | TYPE ⁽¹⁾ | DESCRIPTION |
|-----|-----------|---------------------|---|
| NO. | NAME | | |
| A1 | B2 | I/O | Input/output B2. Referenced to V_{CCB} . |
| A2 | B1 | I/O | Input/output B1. Referenced to V_{CCB} . |
| B1 | GND | S | Ground |
| B2 | V_{CCB} | S | B-port supply voltage. $1.65\text{ V} \leq V_{CCB} \leq 5.5\text{ V}$ |
| C1 | V_{CCA} | S | A-port supply voltage. $1.1\text{ V} \leq V_{CCA} \leq 3.6\text{ V}$, $V_{CCA} \leq V_{CCB}$ |
| C2 | OE | I | 3-state output-mode enable. Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA} |
| D1 | A2 | I/O | Input/output A2. Referenced to V_{CCA} |
| D2 | A1 | I/O | Input/output A1. Referenced to V_{CCA} |

(1) I = input, O = output, I/O = input and output, S = power supply

Pin Functions: DCT or DCU

| PIN | | TYPE ⁽¹⁾ | DESCRIPTION |
|-----------|-----|---------------------|---|
| NAME | NO. | | |
| B2 | 1 | I/O | Input/output B2. Referenced to V_{CCB} |
| GND | 2 | S | Ground |
| V_{CCA} | 3 | S | A-port supply voltage. $1.1\text{ V} \leq V_{CCA} \leq 3.6\text{ V}$, $V_{CCA} \leq V_{CCB}$ |
| A2 | 4 | I/O | Input/output A2. Referenced to V_{CCA} |
| A1 | 5 | I/O | Input/output A1. Referenced to V_{CCA} |
| OE | 6 | I | 3-state output-mode enable. Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA} |
| V_{CCB} | 7 | S | B-port supply voltage. $1.65\text{ V} \leq V_{CCB} \leq 5.5\text{ V}$ |
| B1 | 8 | I/O | Input/output B1. Referenced to V_{CCB} |

(1) I = input, O = output, I/O = input and output, S = power supply

6 Specifications

6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | | MIN | MAX | UNIT | |
|-----------|---|-----------|------|-----------------|------|----|
| V_{CCA} | Supply voltage | | -0.5 | 4.6 | V | |
| V_{CCB} | | | -0.5 | 6.5 | | |
| V_I | Input voltage ⁽²⁾ | A port | -0.5 | 4.6 | V | |
| | | B port | -0.5 | 6.5 | | |
| V_O | Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾ | A port | -0.5 | 4.6 | V | |
| | | B port | -0.5 | 6.5 | | |
| V_O | Voltage range applied to any output in the high or low state ^{(2) (3)} | A port | -0.5 | $V_{CCA} + 0.5$ | V | |
| | | B port | -0.5 | $V_{CCB} + 0.5$ | | |
| I_{IK} | Input clamp current | $V_I < 0$ | | -50 | mA | |
| I_{OK} | Output clamp current | $V_O < 0$ | | -50 | mA | |
| I_O | Continuous output current | | | ±50 | mA | |
| | Continuous current through V_{CCA} , V_{CCB} , or GND | | | ±100 | mA | |
| T_J | Junction temperature | | | 150 | °C | |
| T_{stg} | Storage temperature | | | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

6.2 ESD Ratings

| | | PORTS | VALUE | UNIT |
|--------------------------------|-------------------------|--|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | | V |
| | | A Port | ±2500 | |
| | | B Port | ±1500 | |
| | | Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | | V |
| | | A Port | ±1500 | |
| | | B Port | ±1500 | |
| Machine model (MM), per A115-A | | V | | |
| A Port | ±200 | | | |
| B Port | ±200 | | | |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

See ⁽¹⁾ ⁽²⁾

| | | | V_{CCA} | V_{CCB} | MIN | MAX | UNIT |
|---------------------|--|---------------|----------------|------------------|-----------------------------|-----------------------------|------|
| V_{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V_{CCB} | | | | | 1.65 | 5.5 | |
| V_{IH} | High-level input voltage | Data inputs | 1.2 V to 3.6 V | 1.65 V to 5.5 V | $V_{CCI} \times 0.65^{(3)}$ | V_{CCI} | V |
| | | OE input | 1.2 V to 3.6 V | 1.65 V to 5.5 V | $V_{CCA} \times 0.65$ | 5.5 | |
| V_{IL} | Low-level input voltage | Data inputs | 1.2 V to 5.5 V | 1.65 V to 5.5 V | 0 | $V_{CCI} \times 0.35^{(3)}$ | V |
| | | OE input | 1.2 V to 3.6 V | 1.65 V to 5.5 V | 0 | $V_{CCA} \times 0.35$ | |
| V_O | Voltage range applied to any output in the high-impedance or power-off state | A port | 1.2 V to 3.6 V | 1.65 V to 5.5 V | 0 | 3.6 | V |
| | | B port | | | 0 | 5.5 | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | A port inputs | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 40 | ns/V |
| | | B port inputs | 1.2 V to 3.6 V | 1.65 V to 1.95 V | | 40 | |
| | | | | 4.5 V to 5.5 V | | 30 | |
| T_A | Operating free-air temperature | | | | -40 | 85 | °C |

(1) The A and B sides of an unused data I/O pair must be held in the same state, that is, both at V_{CCI} or both at GND.

(2) V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.

(3) V_{CCI} is the supply voltage associated with the input port.

6.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | TXB0102 | | | UNIT |
|-------------------------------|--|-------------|-------------|-------------|------|
| | | DCT (VSSOP) | DCU (VSSOP) | YZP (VSSOP) | |
| | | 8 PINS | 8 PINS | 8 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 168.7 | 199.1 | 105.8 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 111.7 | 72.4 | 1.6 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 78.1 | 77.8 | 10.8 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 45.0 | 6.2 | 3.1 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 77.5 | 77.4 | 10.9 | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#).

6.5 Electrical Characteristics: $T_A = 25^\circ\text{C}$ (1) (2)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V_{CCA} | V_{CCB} | MIN | TYP | MAX | UNIT |
|---------------------|-------------|--|----------------|-----------------|-----|------|---------|---------------|
| V_{OHA} | | $I_{OH} = -20 \mu\text{A}$ | 1.2 V | | | 1.1 | | V |
| | | | 1.4 V to 3.6 V | | | | | |
| V_{OLA} | | $I_{OL} = 20 \mu\text{A}$ | 1.2 V | | | 0.3 | | V |
| | | | 1.4 V to 3.6 V | | | | | |
| V_{OHB} | | $I_{OH} = -20 \mu\text{A}$ | | 1.65 V to 5.5 V | | | | V |
| V_{OLB} | | $I_{OL} = 20 \mu\text{A}$ | | 1.65 V to 5.5 V | | | | V |
| I_I | OE | $V_I = V_{CCI}$ or GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | | ± 1 | μA |
| I_{off} | A port | V_I or $V_O = 0$ to 3.6 V | 0 V | 0 V to 5.5 V | | | ± 1 | μA |
| | B port | V_I or $V_O = 0$ to 5.5 V | 0 V to 3.6 V | 0 V | | | ± 1 | |
| I_{OZ} | A or B port | OE = GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | | ± 1 | μA |
| I_{CCA} | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | 0.06 | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | |
| | | | 3.6 V | 0 V | | | | |
| | | | 0 V | 5.5 V | | | | |
| I_{CCB} | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | 3.4 | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | |
| | | | 3.6 V | 0 V | | | | |
| | | | 0 V | 5.5 V | | | | |
| $I_{CCA} + I_{CCB}$ | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | 3.5 | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | |
| I_{CCZA} | | $V_I = V_{CCI}$ or GND, $I_O = 0$, OE = GND | 1.2 V | 1.65 V to 5.5 V | | 0.05 | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | |
| I_{CCZB} | | $V_I = V_{CCI}$ or GND, $I_O = 0$, OE = GND | 1.2 V | 1.65 V to 5.5 V | | 3.3 | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | | | |
| C_i | OE | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 2.5 | | pF |
| C_{io} | A port | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 5 | | pF |
| | B port | | | | | 11 | | |

 (1) V_{CCI} is the supply voltage associated with the input port.

 (2) V_{CCO} is the supply voltage associated with the output port.

6.6 Electrical Characteristics: $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ ^{(1) (2)}

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V_{CCA} | V_{CCB} | MIN | MAX | UNIT |
|---------------------|-------------|--|----------------|-----------------|-----------------|---------|---------------|
| V_{OHA} | | $I_{OH} = -20 \mu\text{A}$ | 1.2 V | | $V_{CCA} - 0.4$ | | V |
| | | | 1.4 V to 3.6 V | | | | |
| V_{OLA} | | $I_{OL} = 20 \mu\text{A}$ | 1.2 V | | | 0.4 | V |
| | | | 1.4 V to 3.6 V | | | | |
| V_{OHB} | | $I_{OH} = -20 \mu\text{A}$ | | 1.65 V to 5.5 V | $V_{CCB} - 0.4$ | | V |
| V_{OLB} | | $I_{OL} = 20 \mu\text{A}$ | | 1.65 V to 5.5 V | | 0.4 | V |
| I_I | OE | $V_I = V_{CCI}$ or GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | ± 2 | μA |
| I_{off} | A port | V_I or $V_O = 0$ to 3.6 V | 0 V | 0 V to 5.5 V | | ± 2 | μA |
| | B port | V_I or $V_O = 0$ to 5.5 V | 0 V to 3.6 V | 0 V | | ± 2 | |
| I_{OZ} | A or B port | OE = GND | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | ± 2 | μA |
| I_{CCA} | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | 3 | |
| | | | 3.6 V | 0 V | | 2 | |
| | | | 0 V | 5.5 V | | -2 | |
| I_{CCB} | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | 5 | |
| | | | 3.6 V | 0 V | | -2 | |
| | | | 0 V | 5.5 V | | 2 | |
| $I_{CCA} + I_{CCB}$ | | $V_I = V_{CCI}$ or GND, $I_O = 0$ | 1.2 V | 1.65 V to 5.5 V | | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | 8 | |
| I_{CCZA} | | $V_I = V_{CCI}$ or GND, $I_O = 0$, OE = GND | 1.2 V | 1.65 V to 5.5 V | | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | 3 | |
| I_{CCZB} | | $V_I = V_{CCI}$ or GND, $I_O = 0$, OE = GND | 1.2 V | 1.65 V to 5.5 V | | | μA |
| | | | 1.4 V to 3.6 V | 1.65 V to 5.5 V | | 5 | |
| C_i | OE | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 3 | pF |
| C_{io} | A port | | 1.2 V to 3.6 V | 1.65 V to 5.5 V | | 6 | pF |
| | B port | | | | 14 | | |

 (1) V_{CCI} is the supply voltage associated with the input port.

 (2) V_{CCO} is the supply voltage associated with the output port.

6.7 Operating Characteristics

 $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|-----------------------------|--|------|------|
| C_{pdA} | A port input, B port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 7.8 | pF |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 8 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 8 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 7 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 7 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 8 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 8 | |
| | B port input, A port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 12 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 11 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 11 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 11 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 11 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 11 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 11 | |
| C_{pdB} | A port input, B port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 38.1 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 29 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 29 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 29 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 29 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 30 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 30 | |
| | B port input, A port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 25.4 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 19 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 18 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 18 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 18 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 21 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 21 | |

 $C_L = 0, f = 10\text{ MHz},$
 $t_r = t_f = 1\text{ ns},$
 $OE = V_{CCA}$
 (outputs enabled)

Operating Characteristics (continued)
 $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|-----------------------------|--|------|------|
| C_{pdA} | A port input, B port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | pF |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 0.01 | |
| | B port input, A port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 0.01 | |
| C_{pdB} | A port input, B port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 0.02 | |
| | B port input, A port output | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.2\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.5\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 1.8\text{ V}, V_{CCB} = 1.8\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 2.5\text{ V}$ | 0.01 | |
| | | $V_{CCA} = 2.5\text{ V}, V_{CCB} = 5\text{ V}$ | 0.02 | |
| | | $V_{CCA} = 3.3\text{ V}, V_{CCB} = 3.3\text{ V to }5\text{ V}$ | 0.03 | |

 $C_L = 0, f = 10\text{ MHz},$
 $t_r = t_f = 1\text{ ns},$
 $OE = \text{GND}$
 (outputs disabled)

6.8 $V_{CCA} = 1.2\text{ V}$ Timing Requirements

 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.2\text{ V}$

| | | TEST CONDITIONS | NOM | UNIT | |
|-----------|----------------|--------------------------|--------------------------|------|----|
| Data rate | | $V_{CCB} = 1.8\text{ V}$ | 20 | Mbps | |
| | | $V_{CCB} = 2.5\text{ V}$ | 20 | | |
| | | $V_{CCB} = 3.3\text{ V}$ | 20 | | |
| | | $V_{CCB} = 5\text{ V}$ | 20 | | |
| t_w | Pulse duration | Data inputs | $V_{CCB} = 1.8\text{ V}$ | 50 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 50 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 50 | |
| | | | $V_{CCB} = 5\text{ V}$ | 50 | |

6.9 $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ Timing Requirements

 over recommended operating free-air temperature range, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (unless otherwise noted)

| | | TEST CONDITIONS | MIN | MAX | UNIT |
|-----------|----------------|--|--|-----|------|
| Data rate | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 40 | Mbps |
| | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 40 | |
| | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 40 | |
| | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 40 | |
| t_w | Pulse duration | Data inputs | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 25 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 25 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 25 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 25 | |

6.10 $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ Timing Requirements

 over recommended operating free-air temperature range, $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ (unless otherwise noted)

| | | TEST CONDITIONS | MIN | MAX | UNIT |
|-----------|----------------|--|--|-----|------|
| Data rate | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 60 | Mbps |
| | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 60 | |
| | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 60 | |
| | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 60 | |
| t_w | Pulse duration | Data inputs | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 17 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 17 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 17 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 17 | |

6.11 $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ Timing Requirements

 over recommended operating free-air temperature range, $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted)

| | | TEST CONDITIONS | MIN | MAX | UNIT |
|-----------|----------------|---|---|-----|------|
| Data rate | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 100 | Mbps |
| | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 100 | |
| | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 100 | |
| t_w | Pulse duration | Data inputs | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 10 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 10 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 10 | |

6.12 $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ Timing Requirements

over recommended operating free-air temperature range, $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted)

| | | TEST CONDITIONS | MIN | MAX | UNIT |
|----------------------|-------------|-----------------|---|-----|------|
| Data rate | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 100 | Mbps |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 100 | |
| t_w Pulse duration | Data inputs | | | 10 | ns |
| | | | | 10 | |

6.13 $V_{CCA} = 1.2\text{ V}$ Switching Characteristics

 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.2\text{ V}$

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | TYP | UNIT |
|-----------|-------------------|-------------|--------------------------|-----|---------------|
| t_{pd} | A | B | $V_{CCB} = 1.8\text{ V}$ | 6.9 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 5.7 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 5.3 | |
| | | | $V_{CCB} = 5\text{ V}$ | 5.5 | |
| | B | A | $V_{CCB} = 1.8\text{ V}$ | 7.4 | |
| | | | $V_{CCB} = 2.5\text{ V}$ | 6.4 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 6 | |
| | | | $V_{CCB} = 5\text{ V}$ | 5.8 | |
| t_{en} | OE | A | $V_{CCB} = 1.8\text{ V}$ | 1 | μs |
| | | | $V_{CCB} = 2.5\text{ V}$ | 1 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 1 | |
| | | | $V_{CCB} = 5\text{ V}$ | 1 | |
| | | B | $V_{CCB} = 1.8\text{ V}$ | 1 | |
| | | | $V_{CCB} = 2.5\text{ V}$ | 1 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 1 | |
| | | | $V_{CCB} = 5\text{ V}$ | 1 | |
| t_{dis} | OE | A | $V_{CCB} = 1.8\text{ V}$ | 18 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 15 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 14 | |
| | | | $V_{CCB} = 5\text{ V}$ | 14 | |
| | | B | $V_{CCB} = 1.8\text{ V}$ | 20 | |
| | | | $V_{CCB} = 2.5\text{ V}$ | 17 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 16 | |
| | | | $V_{CCB} = 5\text{ V}$ | 16 | |
| t_{rA} | A port rise time | | $V_{CCB} = 1.8\text{ V}$ | 4.2 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 4.2 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 4.2 | |
| | | | $V_{CCB} = 5\text{ V}$ | 4.2 | |
| t_{fA} | A port fall times | | $V_{CCB} = 1.8\text{ V}$ | 4.2 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 4.2 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 4.2 | |
| | | | $V_{CCB} = 5\text{ V}$ | 4.2 | |
| t_{rB} | B port rise times | | $V_{CCB} = 1.8\text{ V}$ | 2.1 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 1.5 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 1.2 | |
| | | | $V_{CCB} = 5\text{ V}$ | 1.1 | |

$V_{CCA} = 1.2\text{ V}$ Switching Characteristics (continued)
 $T_A = 25^\circ\text{C}$, $V_{CCA} = 1.2\text{ V}$

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | TYP | UNIT |
|---------------|--------------------|-------------|--------------------------|-----|------|
| t_{fB} | B port fall times | | $V_{CCB} = 1.8\text{ V}$ | 2.1 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 1.5 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 1.2 | |
| | | | $V_{CCB} = 5\text{ V}$ | 1.1 | |
| $t_{sk(o)}$ | Channel-to-channel | | $V_{CCB} = 1.8\text{ V}$ | 0.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V}$ | 0.5 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 0.5 | |
| | | | $V_{CCB} = 5\text{ V}$ | 1.4 | |
| Max data rate | | | $V_{CCB} = 1.8\text{ V}$ | 20 | Mbps |
| | | | $V_{CCB} = 2.5\text{ V}$ | 20 | |
| | | | $V_{CCB} = 3.3\text{ V}$ | 20 | |
| | | | $V_{CCB} = 5\text{ V}$ | 20 | |

6.14 $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ Switching Characteristics

 over recommended operating free-air temperature range, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|-------------|--------------------|-------------|--|-----|------|---------------|
| t_{pd} | A | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1.4 | 12.9 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.2 | 10.1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.1 | 10 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.8 | 9.9 | |
| | B | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 0.9 | 14.2 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.7 | 12 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.4 | 11.7 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.3 | 13.7 | |
| t_{en} | OE | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 1 | μs |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| | | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| t_{dis} | OE | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 5.9 | 31 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 5.7 | 25.9 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 5.6 | 23 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 5.7 | 22.4 | |
| | | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 5.4 | 30.3 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 4.9 | 22.8 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 4.8 | 20 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 4.9 | 19.5 | |
| t_{rA} | A port rise times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1.4 | 5.1 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.4 | 5.1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.4 | 5.1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 1.4 | 5.1 | |
| t_{fA} | A port fall times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1.4 | 5.1 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.4 | 5.1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.4 | 5.1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 1.4 | 5.1 | |
| t_{rB} | B port rise times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 0.9 | 4.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.6 | 3.2 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| t_{fB} | B port fall times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 0.9 | 4.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.6 | 3.2 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| $t_{sk(o)}$ | Channel-to-channel | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 0.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 0.5 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 0.5 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 0.5 | |

$V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ Switching Characteristics (continued)

 over recommended operating free-air temperature range, $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$ (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------|-----------------|----------------|--|-----|-----|------|
| Max data rate | | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 40 | | Mbps |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 40 | | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 40 | | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 40 | | |

6.15 $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ Switching Characteristics

 over recommended operating free-air temperature range, $V_{CCA} = 1.8\text{ V} \pm 0.15\text{ V}$ (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|-------------|--------------------|-------------|--|-----|------|---------------|
| t_{pd} | A | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1.6 | 11 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.4 | 7.7 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.3 | 6.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 1.2 | 6.5 | |
| | B | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1.5 | 12 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.3 | 8.4 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1 | 7.6 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.9 | 7.1 | |
| t_{en} | OE | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 1 | μs |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| | | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| t_{dis} | OE | A | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 5.9 | 31 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 5.1 | 21.3 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 5 | 19.3 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 5 | 17.4 | |
| | | B | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 5.4 | 30.3 | |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 4.4 | 20.8 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 4.2 | 17.9 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 4.3 | 16.3 | |
| t_{rA} | A port rise times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1 | 4.2 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.1 | 4.1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.1 | 4.1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 1.1 | 4.1 | |
| t_{fA} | A port fall times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 1 | 4.2 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.1 | 4.1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.1 | 4.1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 1.1 | 4.1 | |
| t_{rB} | B port rise times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 0.9 | 4.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.6 | 3.2 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| t_{fB} | B port fall times | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | 0.9 | 4.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.6 | 3.2 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| $t_{sk(o)}$ | Channel-to-channel | | $V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$ | | 0.5 | ns |
| | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 0.5 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 0.5 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 0.5 | |

$V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ Switching Characteristics (continued)

 over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------|-----------------|----------------|--|-----|-----|------|
| Max data rate | | | $V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 60 | | Mbps |
| | | | $V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | 60 | | |
| | | | $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 60 | | |
| | | | $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$ | 60 | | |

6.16 $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ Switching Characteristics

 over recommended operating free-air temperature range, $V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted)

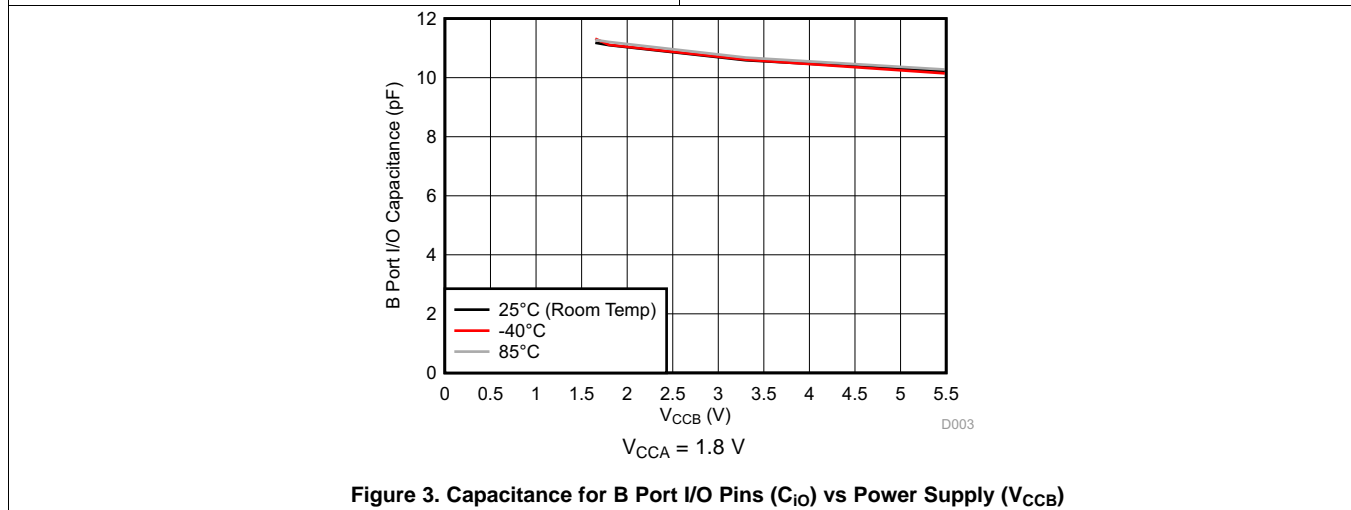
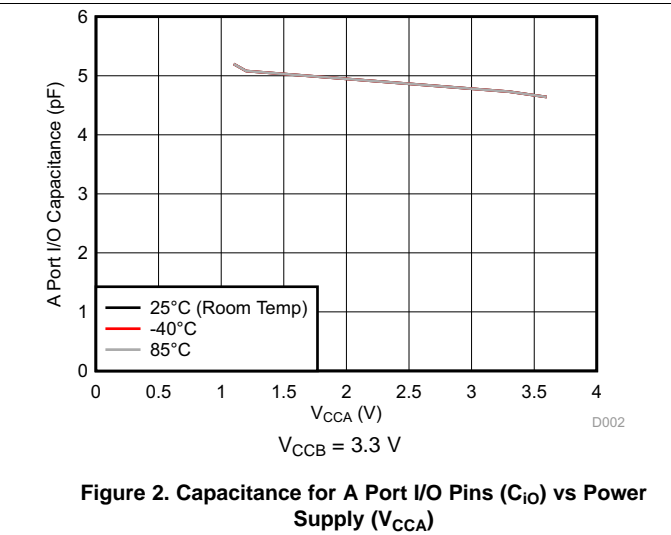
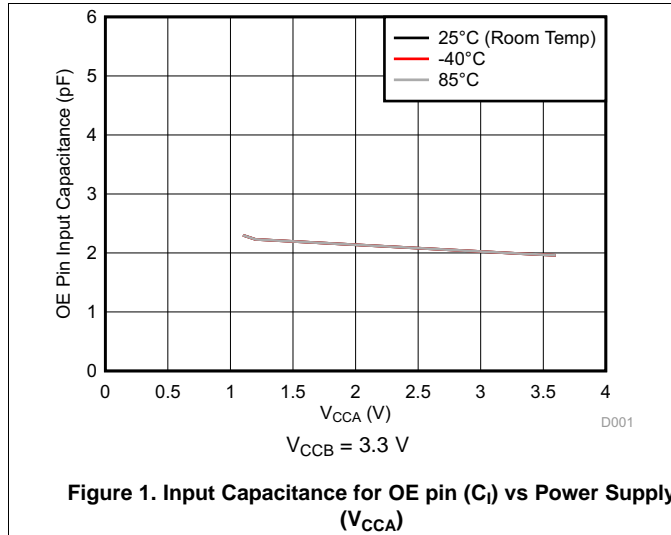
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------|--------------------|-------------|---|-----|------|---------------|
| t_{pd} | A | B | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.1 | 6.3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1 | 5.2 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.9 | 4.7 | |
| | B | A | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 1.2 | 6.6 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.1 | 5.1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.9 | 4.4 | |
| t_{en} | OE | A | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | μs |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| | | B | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| t_{dis} | OE | A | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 5.1 | 21.3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 4.6 | 15.2 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 4.6 | 13.2 | |
| | | B | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 4.4 | 20.8 | |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 3.8 | 16 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 3.9 | 13.9 | |
| t_{rA} | A port rise times | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.8 | 3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.8 | 3 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.8 | 3 | |
| t_{fA} | A port fall times | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.8 | 3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.8 | 3 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.8 | 3 | |
| t_{rB} | B port rise times | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.7 | 3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| t_{fB} | B port fall times | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 0.7 | 3 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.8 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| $t_{sk(o)}$ | Channel-to-channel | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | | 0.5 | ns |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 0.5 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 0.5 | |
| Max data rate | | | $V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$ | 100 | | Mbps |
| | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 100 | | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 100 | | |

6.17 $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ Switching Characteristics

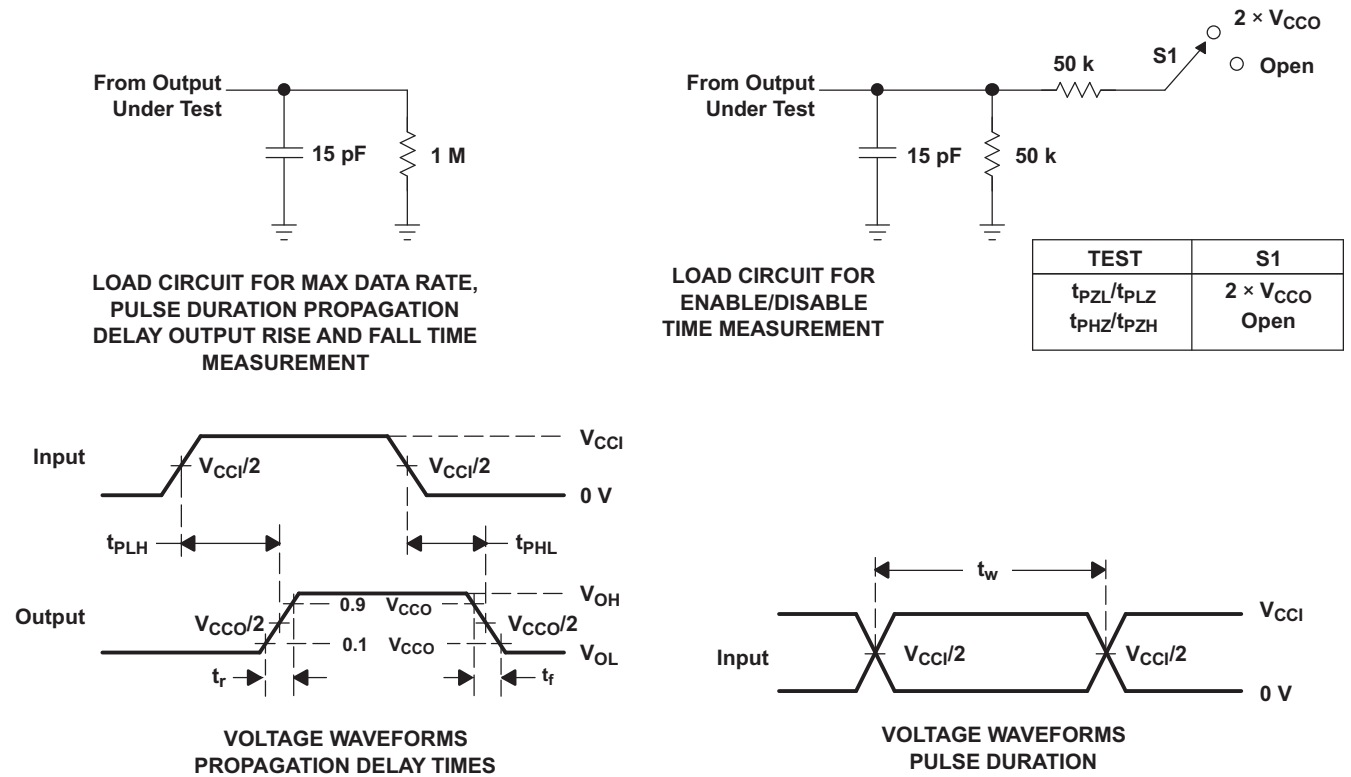
 over recommended operating free-air temperature range, $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------|--------------------|-------------|---|-----|------|---------------|
| t_{pd} | A | B | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.9 | 4.7 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.8 | 4 | |
| | B | A | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1 | 4.9 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.9 | 4.5 | |
| t_{en} | OE | A | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | μs |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| | | B | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 1 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 1 | |
| t_{dis} | OE | A | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 4.6 | 15.2 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 4.3 | 12.1 | |
| | | B | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 3.8 | 16 | |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 3.4 | 13.2 | |
| t_{rA} | A port rise times | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.7 | 2.5 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.7 | 2.5 | |
| t_{fA} | A port fall times | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.7 | 2.5 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | | |
| t_{rB} | B port rise times | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.3 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| t_{fB} | B port fall times | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 0.5 | 2.3 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 0.4 | 2.7 | |
| $t_{sk(o)}$ | Channel-to-channel | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | | 0.5 | ns |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | | 0.5 | |
| Max data rate | | | $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$ | 100 | | Mbps |
| | | | $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ | 100 | | |

6.18 Typical Characteristics



7 Parameter Measurement Information



- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR = 10 MHz, $Z_O = 50 \Omega$, $dv/dt \geq 1$ V/ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .
- E. V_{CCI} is the V_{CC} associated with the input port.
- F. V_{CCO} is the V_{CC} associated with the output port.
- G. All parameters and waveforms are not applicable to all devices.

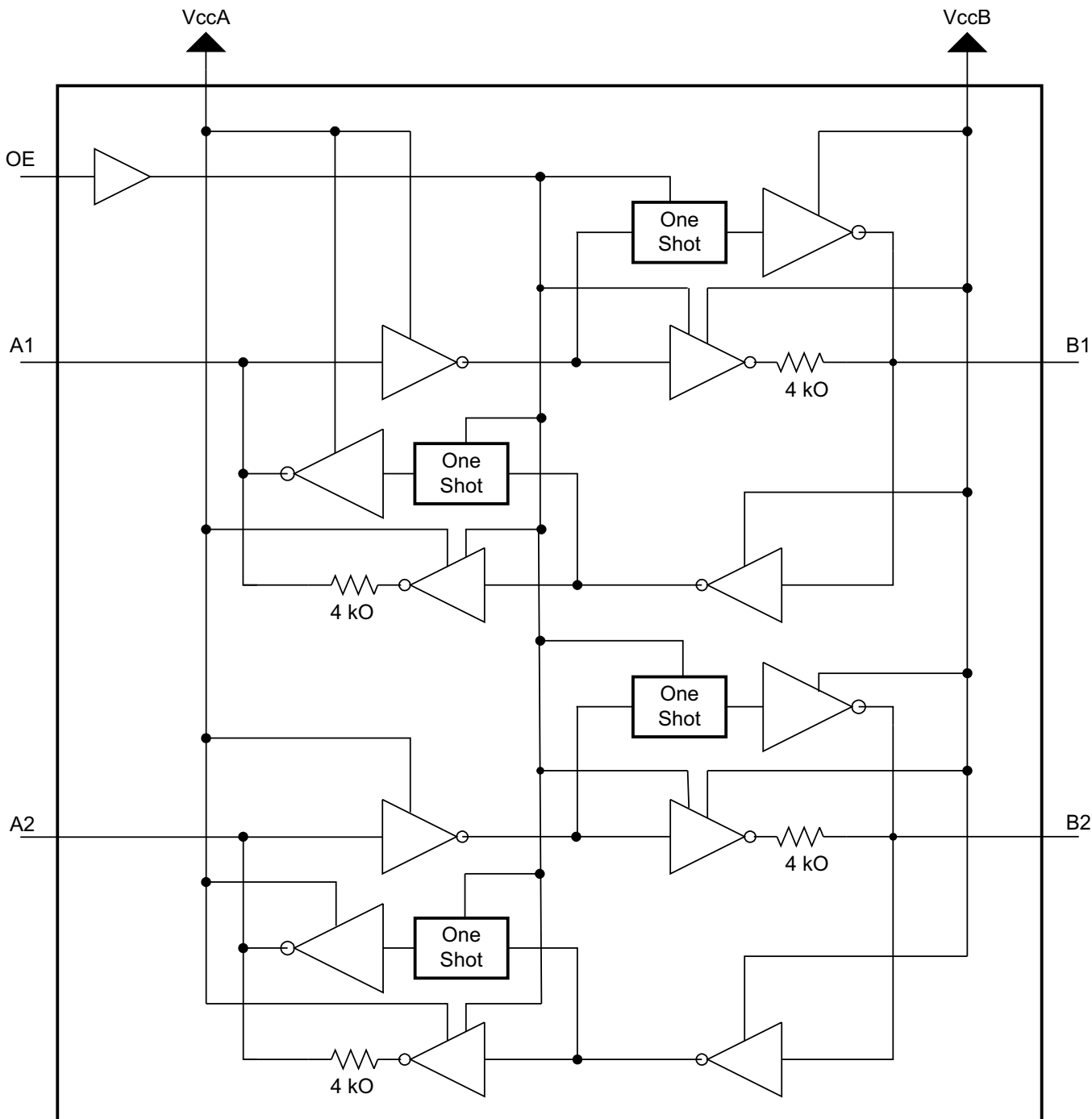
Figure 4. Load Circuits And Voltage Waveforms

8 Detailed Description

8.1 Overview

The TXB0102 device is a 4-bit directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The device is a buffered architecture with edge rate accelerators (one shots) to improve the overall data rate. This device can only translate push-pull CMOS logic outputs. For open drain signal translation, see TI TXS010X products.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Architecture

The TXB0102 architecture (see [Figure 5](#)) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a DC state, the output drivers of the TXB0102 can maintain a high or low, but are designed to be weak, so that the drivers can be overdriven by an external driver when data on the bus starts flowing the opposite direction. The output one shots detect rising or falling edges on the A or B ports. During a rising edge, the one shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70 Ω at $V_{CCO} = 1.2\text{ V}$ to 1.8 V, 50 Ω at $V_{CCO} = 1.8\text{ V}$ to 3.3 V and 40 Ω at $V_{CCO} = 3.3\text{ V}$ to 5 V.

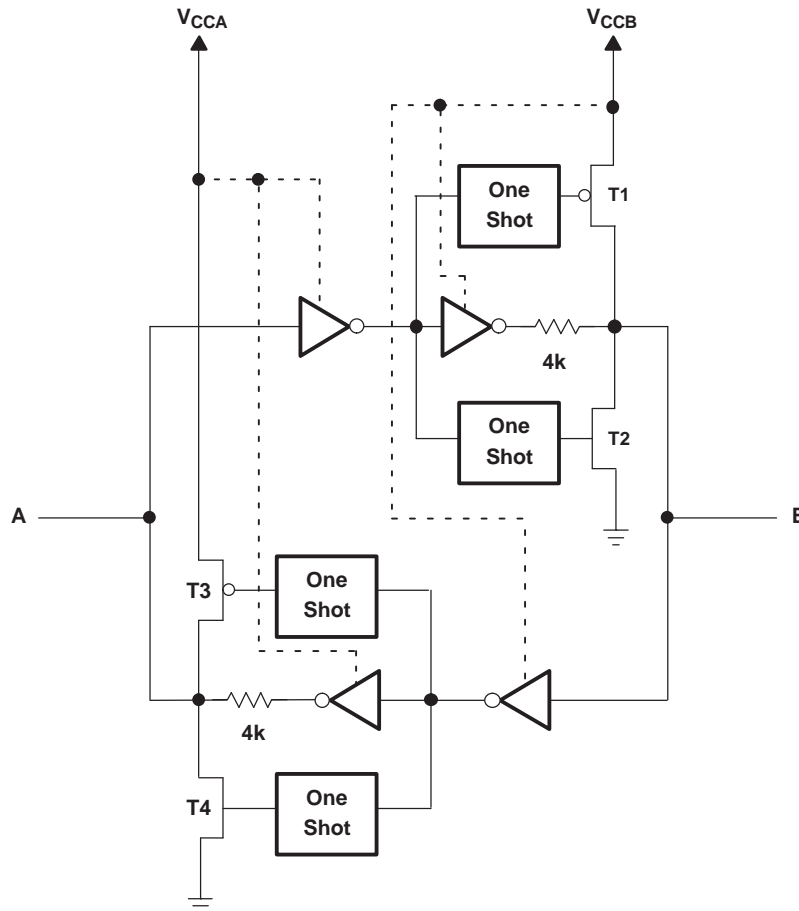


Figure 5. Architecture of TXB0102 I/O Cell

8.3.2 Input Driver Requirements

[Figure 6](#) shows the typical I_{IN} versus V_{IN} characteristics of the TXB0102. For proper operation, the device driving the data I/Os of the TXB0102 must have drive strength of at least $\pm 2\text{ mA}$.

Feature Description (continued)

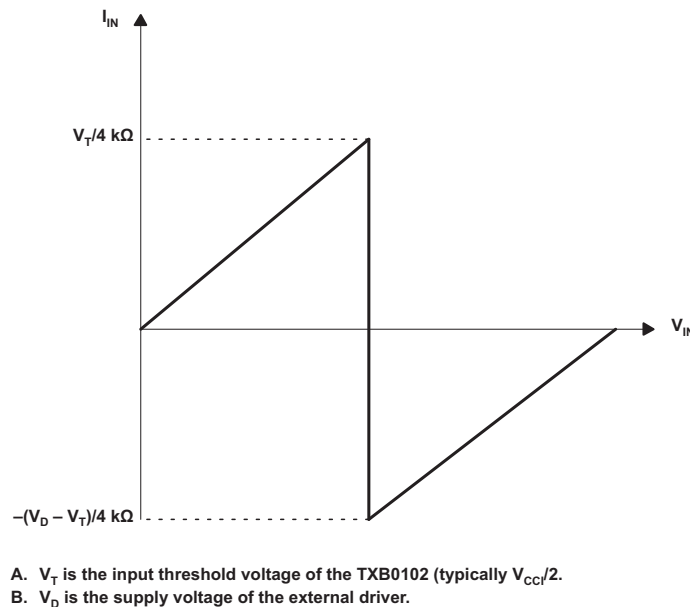


Figure 6. Typical I_{IN} vs V_{IN} Curve

8.3.3 Output Load Considerations

TI recommends careful printed-circuit board (PCB) layout practices with short PCB trace lengths to avoid excessive capacitive loading and to assure that proper O.S. triggering takes place. PCB signal trace-lengths must be kept short enough such that the round trip delay of any reflection is less than the one-shot duration. This improves signal integrity by assuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 10 ns. The maximum capacitance of the lumped load that is driven also depends directly on the one-shot duration. With heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic ICC, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the TXB0102 output sees, so TI recommends that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.

8.3.4 Enable and Disable

The TXB0102 has an output-enable (OE) input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

8.3.5 Pullup or Pulldown Resistors on I/O Lines

The TXB0102 is designed to drive capacitive loads of up to 70 pF. The output drivers of the TXB0102 have low DC drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 kΩ to assure that they do not contend with the output drivers of the TXB0102.

For the same reason, the TXB0102 device must not be used in applications such as I2C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the TI TXS01xx series of level translators.

8.4 Device Functional Modes

The TXB0102 device has two functional modes, enabled and disabled. To disable the device set the OE input low, which places all I/Os in a high impedance state. Setting the OE input high enables the device.

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TXB0102 is used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. If for open drain signal translation, please refer to TI TXS010X products. Any external pulldown or pullup resistors are recommended larger than 50 k Ω .

9.2 Typical Application

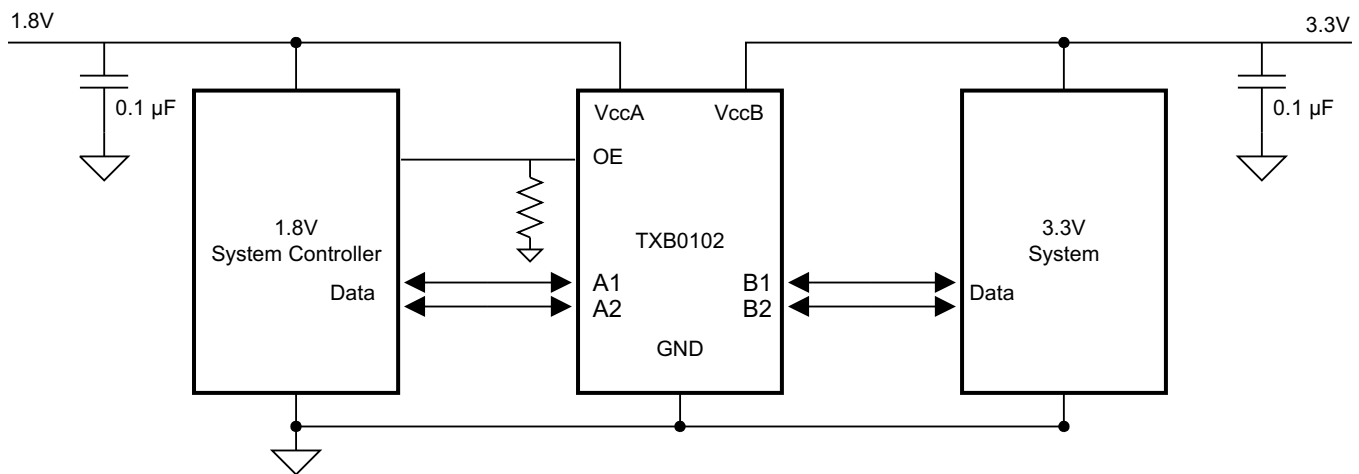


Figure 7. Typical Operating Circuit

9.2.1 Design Requirements

For this design example, use the parameters listed in [Table 1](#) and make sure that $V_{CCA} \leq V_{CCB}$.

Table 1. Design Parameters

| DESIGN PARAMETER | EXAMPLE VALUE |
|----------------------|-----------------|
| Input voltage range | 1.2 V to 3.6 V |
| Output voltage range | 1.65 V to 5.5 V |

9.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
 - Use the supply voltage of the device that is driving the TXB0102 device to determine the input voltage range. For a valid logic high the value must exceed the V_{IH} of the input port. For a valid logic low the value must be less than the V_{IL} of the input port.
- Output voltage range
 - Use the supply voltage of the device that the TXB0102 device is driving to determine the output voltage range.
 - TI does not recommend to have the external pullup or pulldown resistors. If mandatory, TI recommends that the value should be larger than 50 k Ω .

- An external pulldown or pullup resistor decreases the output V_{OH} and V_{OL} . Use [Equation 1](#) and [Equation 2](#) to draft estimate the V_{OH} and V_{OL} as a result of an external pulldown and pullup resistor.

$$V_{OH} = V_{CCx} \times R_{PD} / (R_{PD} + 4.5 \text{ k}\Omega) \tag{1}$$

$$V_{OL} = V_{CCx} \times 4.5 \text{ k}\Omega / (R_{PU} + 4.5 \text{ k}\Omega)$$

where

- V_{CCx} is the output port supply voltage on either V_{CCA} or V_{CCB}
- R_{PD} is the value of the external pulldown resistor
- R_{PU} is the value of the external pullup resistor
- 4.5 k Ω is the counting the variation of the serial resistor 4 k Ω in the I/O line. (2)

9.2.3 Application Curve

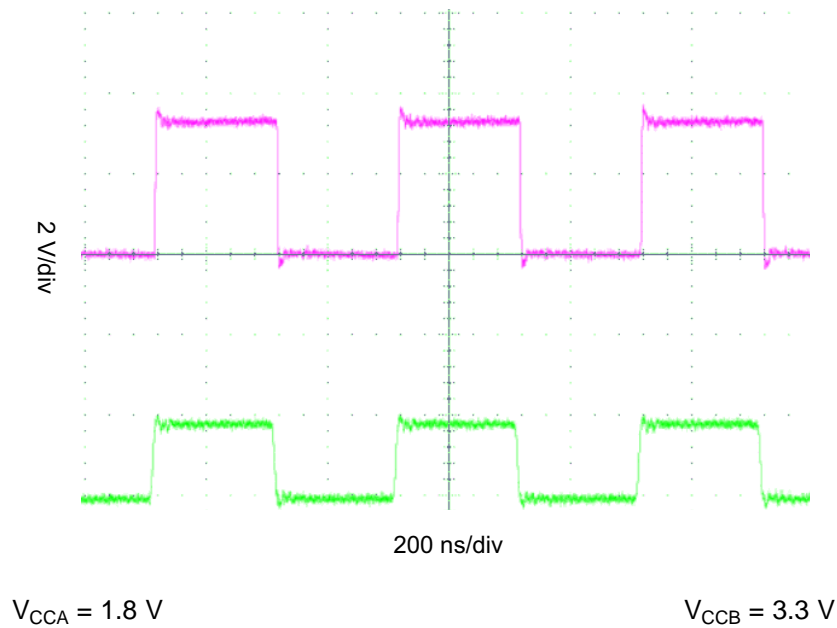


Figure 8. Level-Translation of a 2.5-MHz Signal

10 Power Supply Recommendations

During operation, assure that $V_{CCA} \leq V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \geq V_{CCB}$ does not damage the device, so any power supply can be ramped up first. The TXB0102 device has circuitry that disables all output ports when either V_{CC} is switched off ($V_{CCA/B} = 0\text{ V}$). The (OE) input circuit is designed so that it is supplied by V_{CCA} and when the (OE) input is low, all outputs are placed in the high-impedance state. To assure the high-impedance state of the outputs during power up or power down, the OE input pin must be tied to GND through a pulldown resistor and must not be enabled until V_{CCA} and V_{CCB} are fully ramped and stable. The minimum value of the pulldown resistor to ground is determined by the current-sourcing capability of the driver.

11 Layout

11.1 Layout Guidelines

Follow common PCB layout guidelines to assure reliability of the device.

Bypass capacitors must be used on power supplies and placed as close as possible to the V_{CCA} , V_{CCB} pin, and GND pin.

Short trace lengths must be used to avoid excessive loading.

PCB signal trace-lengths must be kept short enough so that the round-trip delay of any reflection is less than the oneshot duration, approximately 10 ns, assuring that any reflection encounters low impedance at the source driver.

11.2 Layout Example

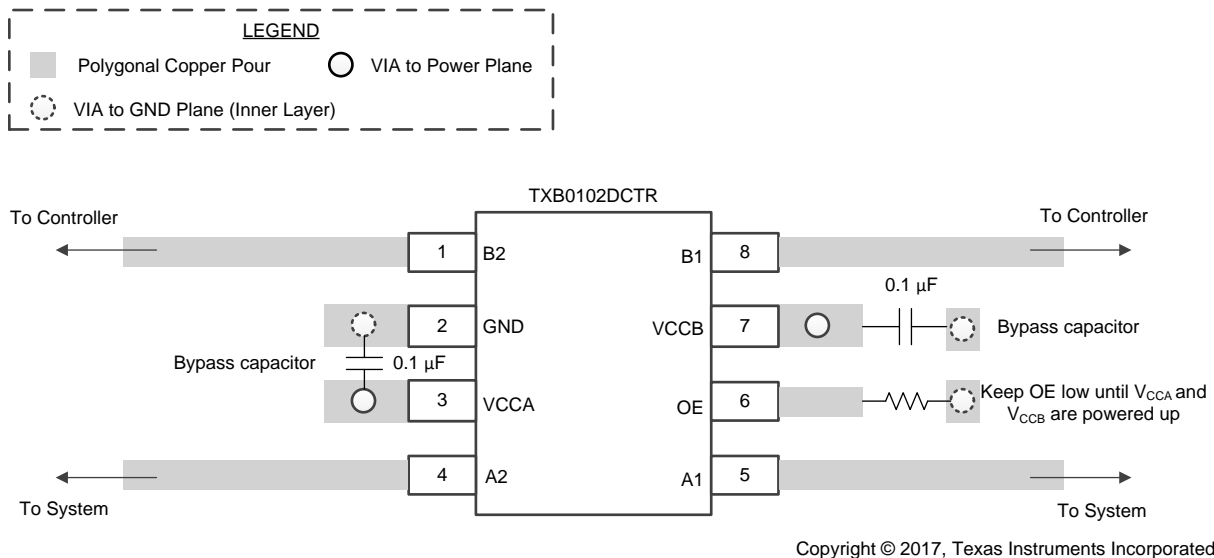


Figure 9. TXB0102 Layout Example

12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [A Guide to Voltage Translation With TXB-Type Translators Application Report](#)
- Texas Instruments, [Effects of pullup and pulldown resistors on TXS and TXB devices Application Report](#)
- Texas Instruments, [Introduction to Logic Application Report](#)
- Texas Instruments, [A Guide to Voltage Translation With TXS-Type Translators Application Report](#)
- Texas Instruments, [A Guide to Voltage Translation With TXB-Type Translators Application Report](#)

12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.4 Trademarks

NanoFree, E2E are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TXB0102DCUR | ACTIVE | VSSOP | DCU | 8 | 3000 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 85 | (FD, NFDQ, NFDR) NZ | Samples |
| TXB0102DCURG4 | ACTIVE | VSSOP | DCU | 8 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | NFDR | Samples |
| TXB0102DCUT | ACTIVE | VSSOP | DCU | 8 | 250 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 85 | (FD, NFDQ, NFDR) NZ | Samples |
| TXB0102DCUTG4 | ACTIVE | VSSOP | DCU | 8 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | NFDR | Samples |
| TXB0102YZPR | ACTIVE | DSBGA | YZP | 8 | 3000 | RoHS & Green | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | (2E, 2E2, 2EN) | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TXB0102DCUR | VSSOP | DCU | 8 | 3000 | 180.0 | 8.4 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |
| TXB0102DCURG4 | VSSOP | DCU | 8 | 3000 | 180.0 | 8.4 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |
| TXB0102YZPR | DSBGA | YZP | 8 | 3000 | 180.0 | 8.4 | 1.02 | 2.02 | 0.63 | 4.0 | 8.0 | Q1 |
| TXB0102YZPR | DSBGA | YZP | 8 | 3000 | 178.0 | 9.2 | 1.02 | 2.02 | 0.63 | 4.0 | 8.0 | Q1 |

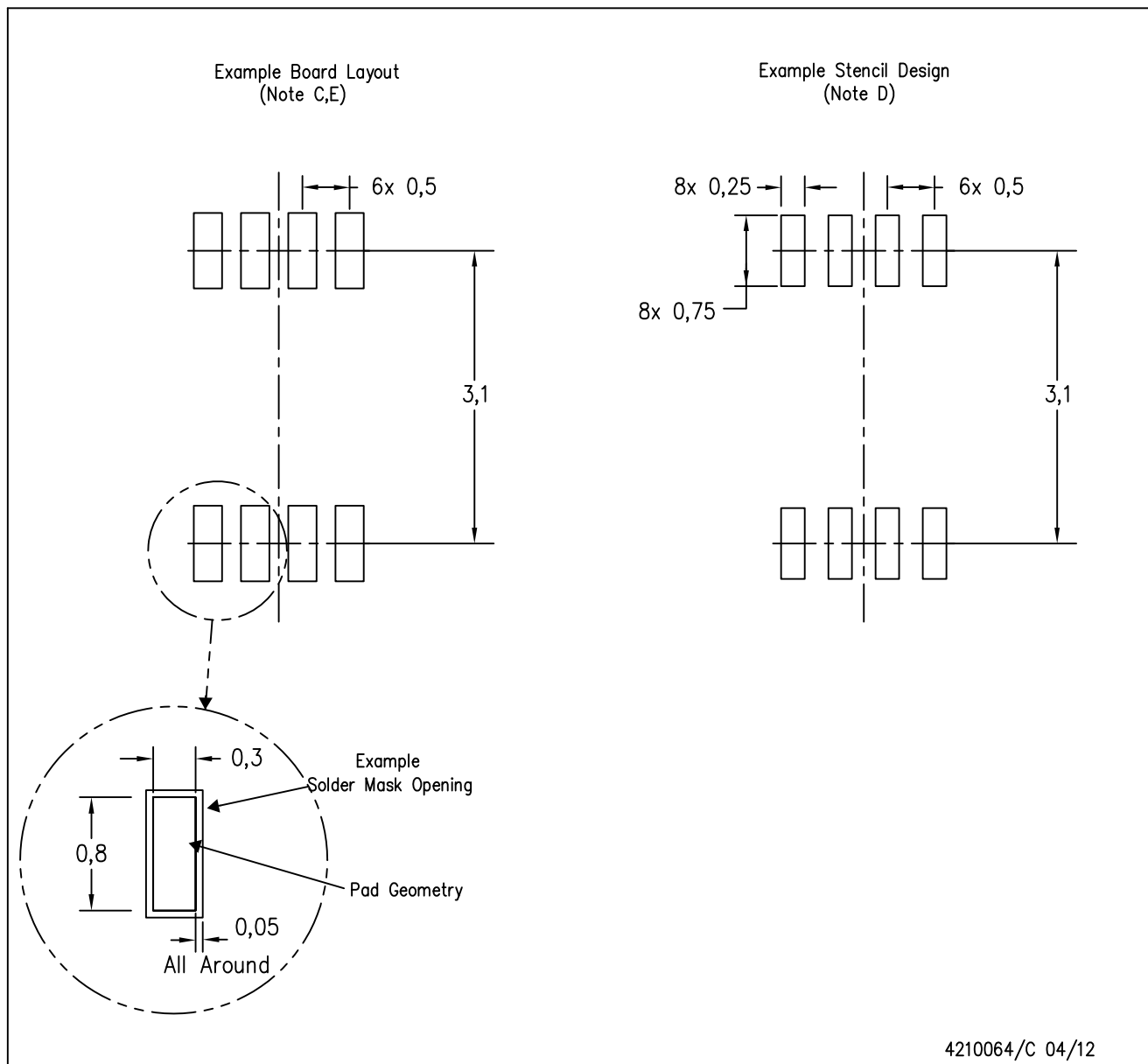
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TXB0102DCUR | VSSOP | DCU | 8 | 3000 | 202.0 | 201.0 | 28.0 |
| TXB0102DCURG4 | VSSOP | DCU | 8 | 3000 | 183.0 | 183.0 | 20.0 |
| TXB0102YZPR | DSBGA | YZP | 8 | 3000 | 182.0 | 182.0 | 20.0 |
| TXB0102YZPR | DSBGA | YZP | 8 | 3000 | 220.0 | 220.0 | 35.0 |

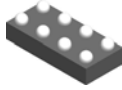
DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

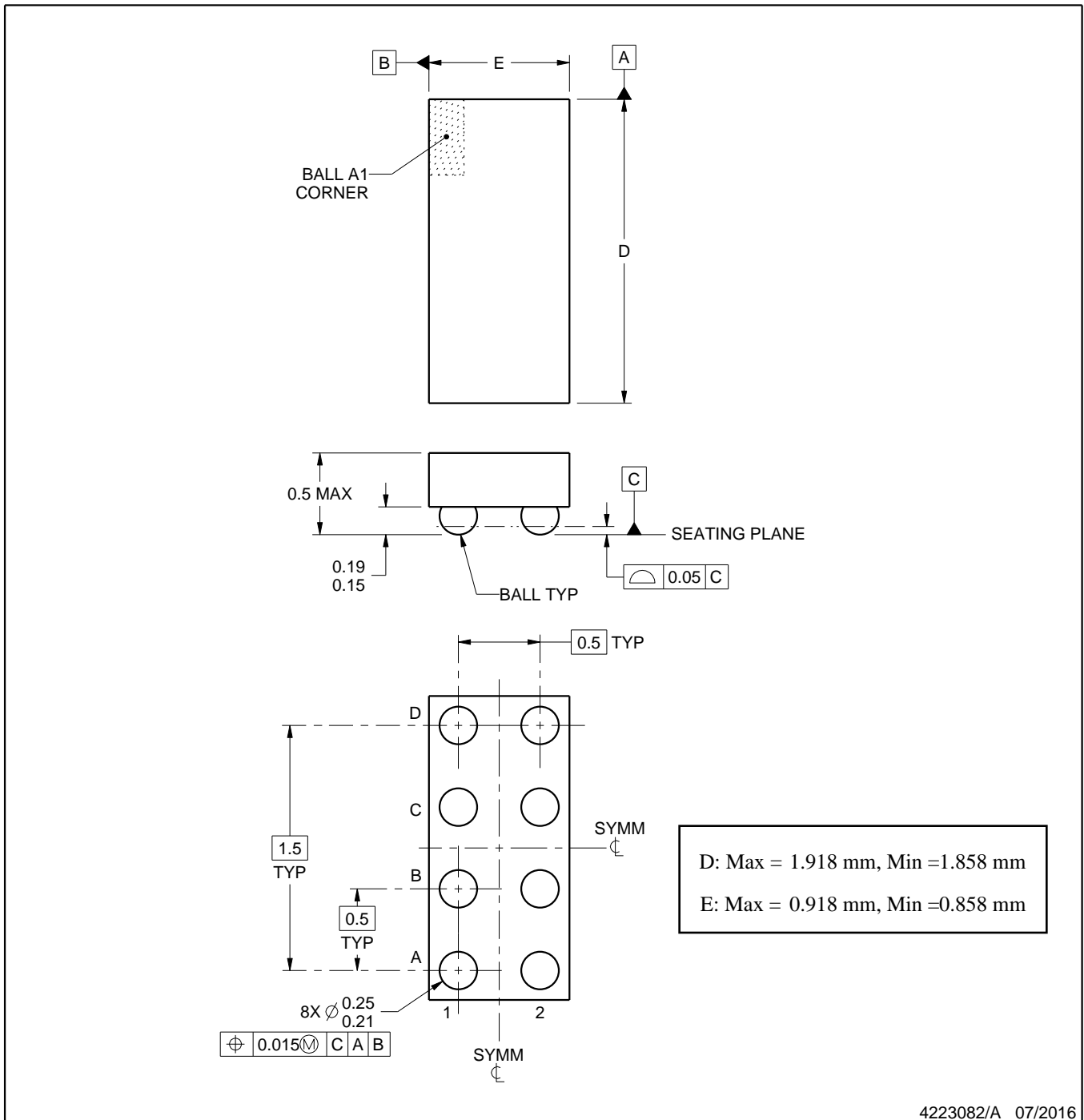
YZP0008



PACKAGE OUTLINE

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



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NOTES:

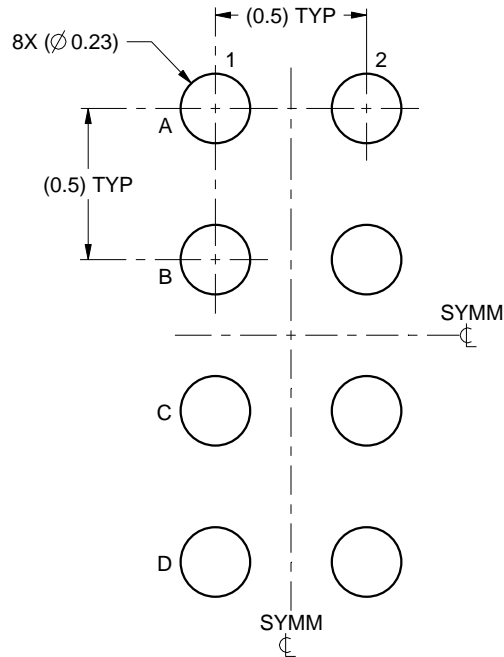
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

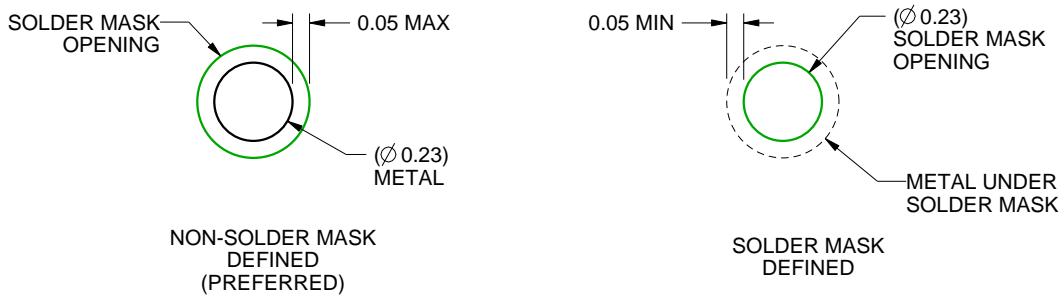
YZP0008

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE
SCALE:40X



SOLDER MASK DETAILS
NOT TO SCALE

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NOTES: (continued)

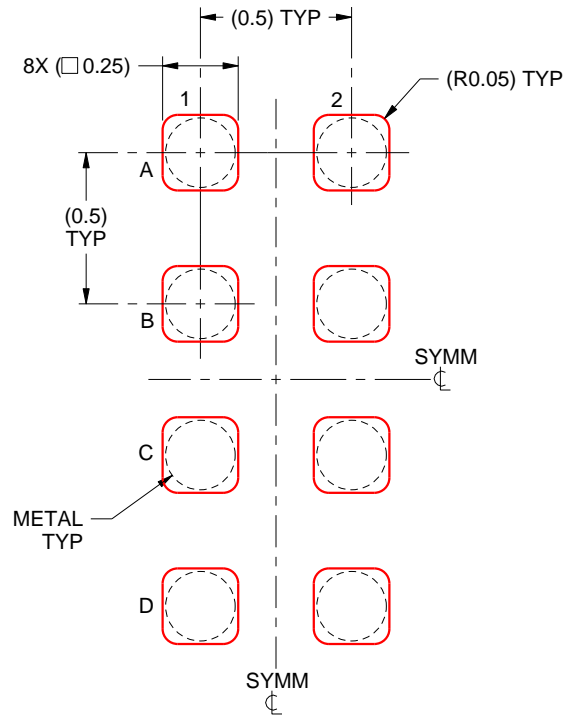
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).

EXAMPLE STENCIL DESIGN

YZP0008

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE
BASED ON 0.1 mm THICK STENCIL
SCALE:40X

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NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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